## KS DMLS31.23

#### SYNIOS® P2720

This compact LED device is part of the SYNIOS P2720 family. Given the scalability of this product family, it provides full performance and flexibility with just one footprint.

The KS DMLS31.23 product is meant to provide superior light quality in 1 mm<sup>2</sup> chip size class.







#### **Applications**

ArchitectureSignalling

Interior Illumination (e.g. Ambient Map)

#### Features:

- Package: SMD epoxy package

- Chip technology: Thinfilm

- Typ. Radiation: 120° (Lambertian emitter)

— Color: λ<sub>dom</sub> = 632 nm (● super red)

- Corrosion Robustness Class: 3B

 Qualifications: The product qualification test plan is based on the guidelines of IEC60810, Lamps for road vehicles – Performance requirements – Requirements and test conditions for LED packages.

- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

### **Ordering Information**

Туре	Luminous Flux <sup>1)</sup> $I_F = 700 \text{ mA}$ $\Phi_V$	Ordering Code
KS DMLS31.23-6J8K-68-M3W3	50 112 lm	Q65112A0162



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T <sub>op</sub>	min.	-40 °C 125 °C
Storage Temperature	T <sub>stg</sub>	max.	-40 °C
Junction Temperature	T <sub>j</sub>	max.	125 °C 150 °C
Junction Temperature for short time applications	$T_{j}$	max.	175 °C
Forward current T <sub>S</sub> = 25 °C	I <sub>F</sub>	min. max.	20 mA 1000 mA
Surge Current t $\leq$ 10 µs; D = 0.005 ; T <sub>s</sub> = 25 °C	l <sub>FS</sub>	max.	2500 mA
Reverse voltage <sup>2)</sup> T <sub>S</sub> = 25 °C	$V_R$	max.	12 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	$V_{ESD}$		2 kV

<sup>\*</sup>The median lifetime (L70/B50) for Tj =175 $^{\circ}$ C is 100h.



### **Characteristics**

 $I_F$  = 700 mA;  $T_S$  = 25 °C

Parameter	Symbol		Values
Peak Wavelength 3)	$\lambda_{\sf peak}$	typ.	644 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	627 nm
$I_{\rm F} = 700  \text{mA}$	dom	typ.	632 nm
•		max.	637 nm
Spectral Bandwidth at 50% I <sub>rel,max</sub>	Δλ	typ.	16 nm
Viewing angle at 50 % I <sub>v</sub>	2φ	typ.	120 °
Forward Voltage 4)	V <sub>F</sub>	min.	2.15 V
$I_{\rm F} = 700  \text{mA}$	·	typ.	2.43 V
		max.	2.75 V
Reverse current 2)	I <sub>R</sub>	typ.	0.2 μΑ
V <sub>R</sub> = 12 V	TX	max.	10 µA
Real thermal resistance junction/solderpoint 5)	R <sub>thJS real</sub>	typ.	9.0 K / W
	tiboreal	max.	11.5 K / W
Electrical thermal resistance junction/solderpoint 5)	R <sub>thJS elec.</sub>	typ.	6.3 K / W
with efficiency $\eta_e$ = 30 %	thoo elec.	max.	8.1 K / W



# **Brightness Groups**

Group	Luminous Flux <sup>1)</sup> $I_F = 700 \text{ mA}$ min. $\Phi_V$	Luminous Flux <sup>1)</sup> $I_F = 700 \text{ mA}$ max. $\Phi_V$	Luminous Intensity <sup>6)</sup> I <sub>F</sub> = 700 mA typ. I <sub>v</sub>
6J	50 lm	56 lm	18 cd
7J	56 lm	63 lm	20 cd
8J	63 lm	71 lm	22 cd
5K	71 lm	80 lm	25 cd
6K	80 lm	90 lm	28 cd
7K	90 lm	100 lm	31 cd
8K	100 lm	112 lm	35 cd

# **Forward Voltage Groups**

Group	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 700 mA min. V <sub>F</sub>	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 700 mA max. V <sub>F</sub>	
M3	2.15 V	2.30 V	
Q3	2.30 V	2.45 V	
T3	2.45 V	2.60 V	
W3	2.60 V	2.75 V	

# **Wavelength Groups**

Group	Dominant Wavelength 3)	Dominant Wavelength 3)
	$I_{F} = 700 \text{ mA}$	$I_{F} = 700 \text{ mA}$
	min.	max.
	$\lambda_{dom}$	$\lambda_{dom}$
6	627 nm	630 nm
7	630 nm	634 nm
8	634 nm	637 nm



## **Group Name on Label**

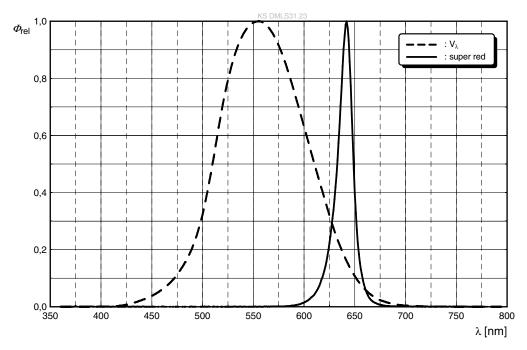
Example: 5K-6-M3

Brightness	Wavelength	Forward Voltage
5K	6	M3



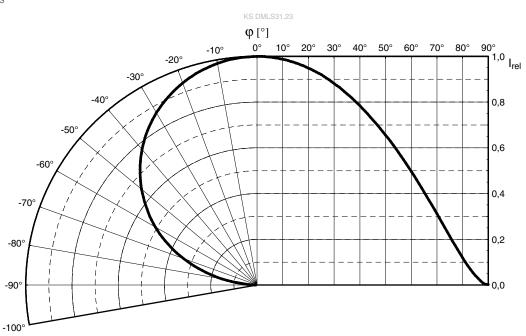
### Relative Spectral Emission 6)

$$\Phi_{rel}$$
 = f ( $\lambda$ ); I $_F$  = 700 mA; T $_S$  = 25 °C



## Radiation Characteristics 6)

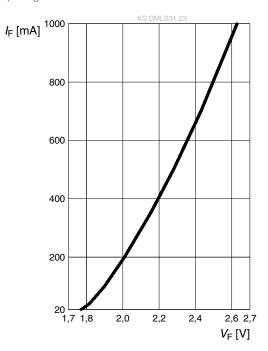
$$I_{rel} = f(\phi); T_S = 25 °C$$





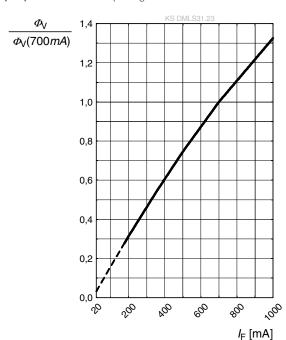
### Forward current 6), 7)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



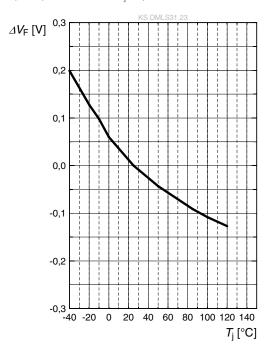
### Relative Luminous Flux 6), 7)

$$\Phi_{V}/\Phi_{V}(700 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$



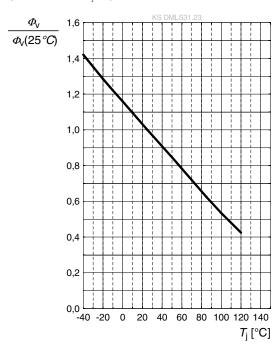
#### Forward Voltage 6)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25 \ ^{\circ}C) = f(T_{_j}); \ I_{_F} = 700 \ \text{mA}$$



#### Relative Luminous Flux 6)

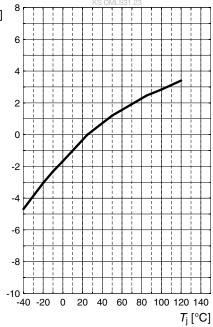
$$\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 700 \text{ mA}$$



## **Dominant Wavelength** 6)

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom} (25~^{\circ}C) = f(T_{j});~I_{F} = 700~mA$$

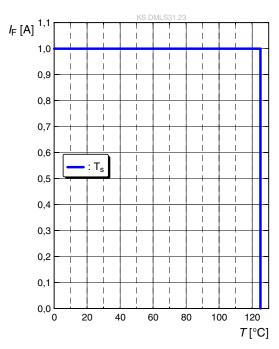
Δλ <sub>dom</sub> [nm]





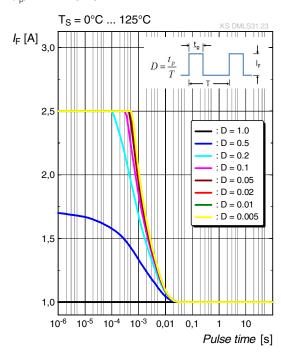
### Max. Permissible Forward Current

 $I_F = f(T)$ 



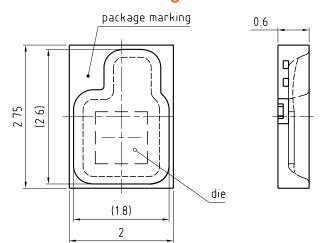
## Permissible Pulse Handling Capability

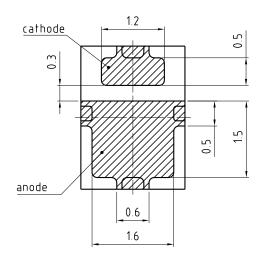
 $I_F = f(t_p)$ ; D: Duty cycle





## **Dimensional Drawing** 8)





General tolerance ±0.1

Lead finish Au

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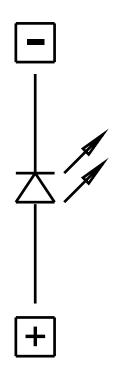
**Approximate Weight:** 12.0 mg

Corrosion test: Class: 3B

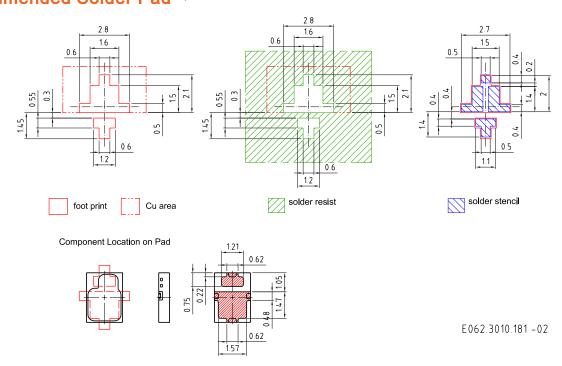
Test condition: 40°C / 90 % RH / 15 ppm  $\rm H_2S$  / 14 days (stricter then IEC

60068-2-43)

#### **Electrical internal circuit**



## Recommended Solder Pad 8)

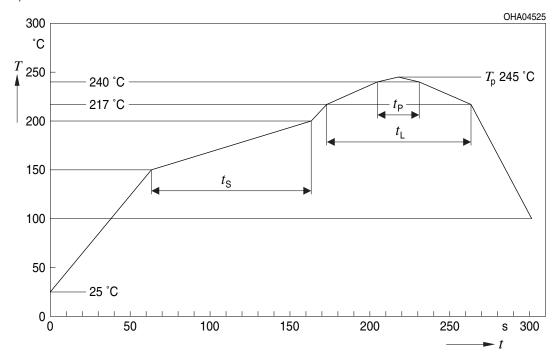


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



### **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



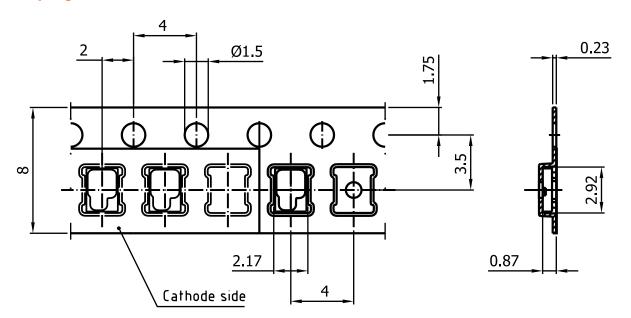
Profile Feature	Symbol	ymbol Pb-Free (SnAgCu) Assembly Unit		Unit	
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)			2	3	K/s
25 °C to 150 °C					
Time t <sub>s</sub>	$t_s$	60	100	120	S
$T_{Smin}$ to $T_{Smax}$					
Ramp-up rate to peak*)			2	3	K/s
$T_{Smax}$ to $T_{P}$					
Liquidus temperature	$T_{L}$		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	T <sub>P</sub>		245	260	°C
Time within 5 °C of the specified peak	t <sub>P</sub>	10	20	30	S
temperature T <sub>P</sub> - 5 K					
Ramp-down rate*			3	6	K/s
T <sub>P</sub> to 100 °C					
Time				480	S
25 °C to T <sub>P</sub>					

All temperatures refer to the center of the package, measured on the top of the component



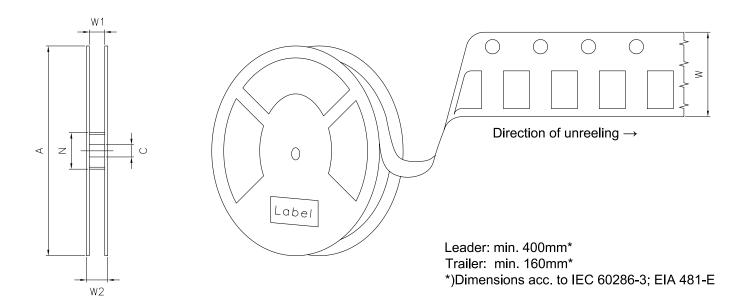
<sup>\*</sup> slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

# Taping 8)



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## Tape and Reel 9)

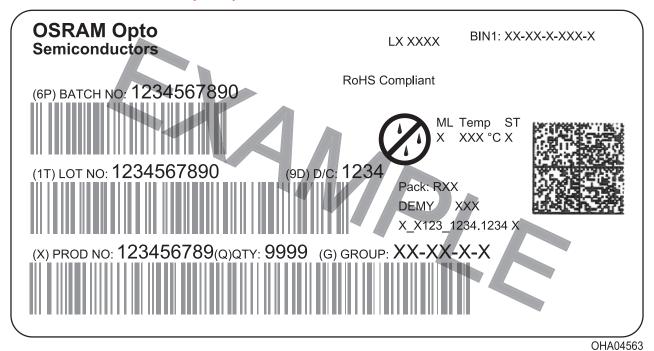


## Reel dimensions [mm]

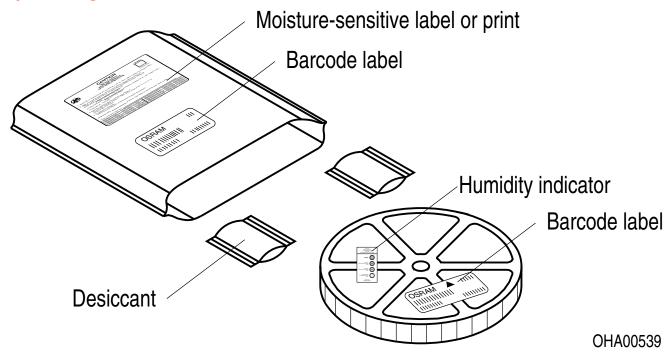
Α	W	$N_{min}$	$W_1$	$W_{2\text{max}}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	2000



#### **Barcode-Product-Label (BPL)**



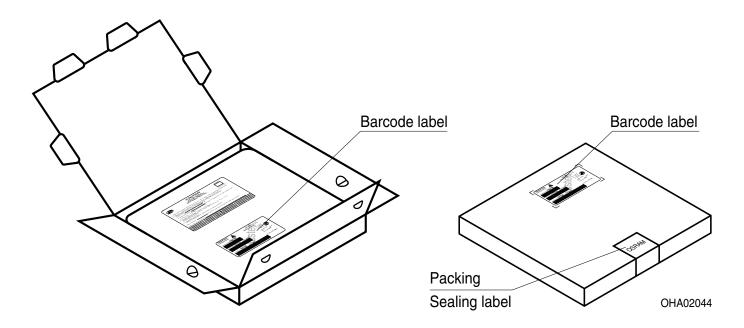
### Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



# Transportation Packing and Materials 8)



# Dimensions of transportation box in mm

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm



#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes



#### **Disclaimer**

#### Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS webside.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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#### Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8$  % and an expanded uncertainty of  $\pm 11$  % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of k = 3).
- Thermal Resistance: Rth max is based on statistic values  $(6\sigma)$ .
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- <sup>9)</sup> **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



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